

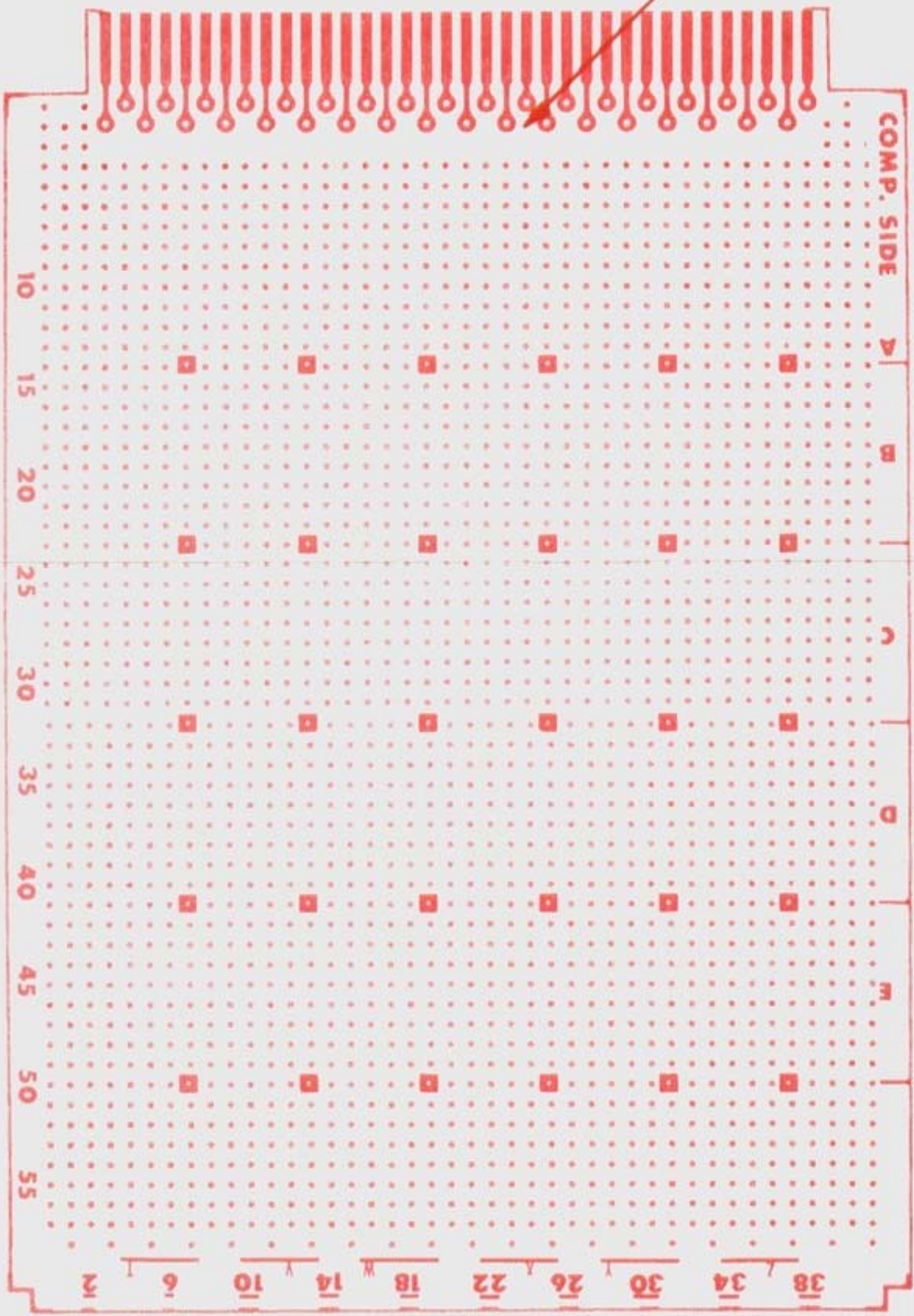
NOTICE: Where tin coated circuitry exists a small percentage of the holes may have solder blockage. This is usually a light "skin" easily penetrated by component leads. In some cases, a soldering iron may be required.



= NO. 1 DIP PIN POSITION

- NOTES
1. ZONE LETTERS A,B,C, ETC. ON Y AXIS AND X,Y,Z ON X AXIS MARK
  2. DOTTED CIRCLES REPRESENT PLUG PADS ON OPPOSITE SIDE OF BOARD.
  3. INTENDED FOR USE IN NON-HOSTILE ENVIRONMENTS UP TO 200 VOLTS RMS OR 300 VOLTS DC.

CAUTION: In any plug contact area on either side of Plugboard, use only those holes having pads. Holes without pads may have insufficient clearance to adjacent circuitry and using them could cause shorting.

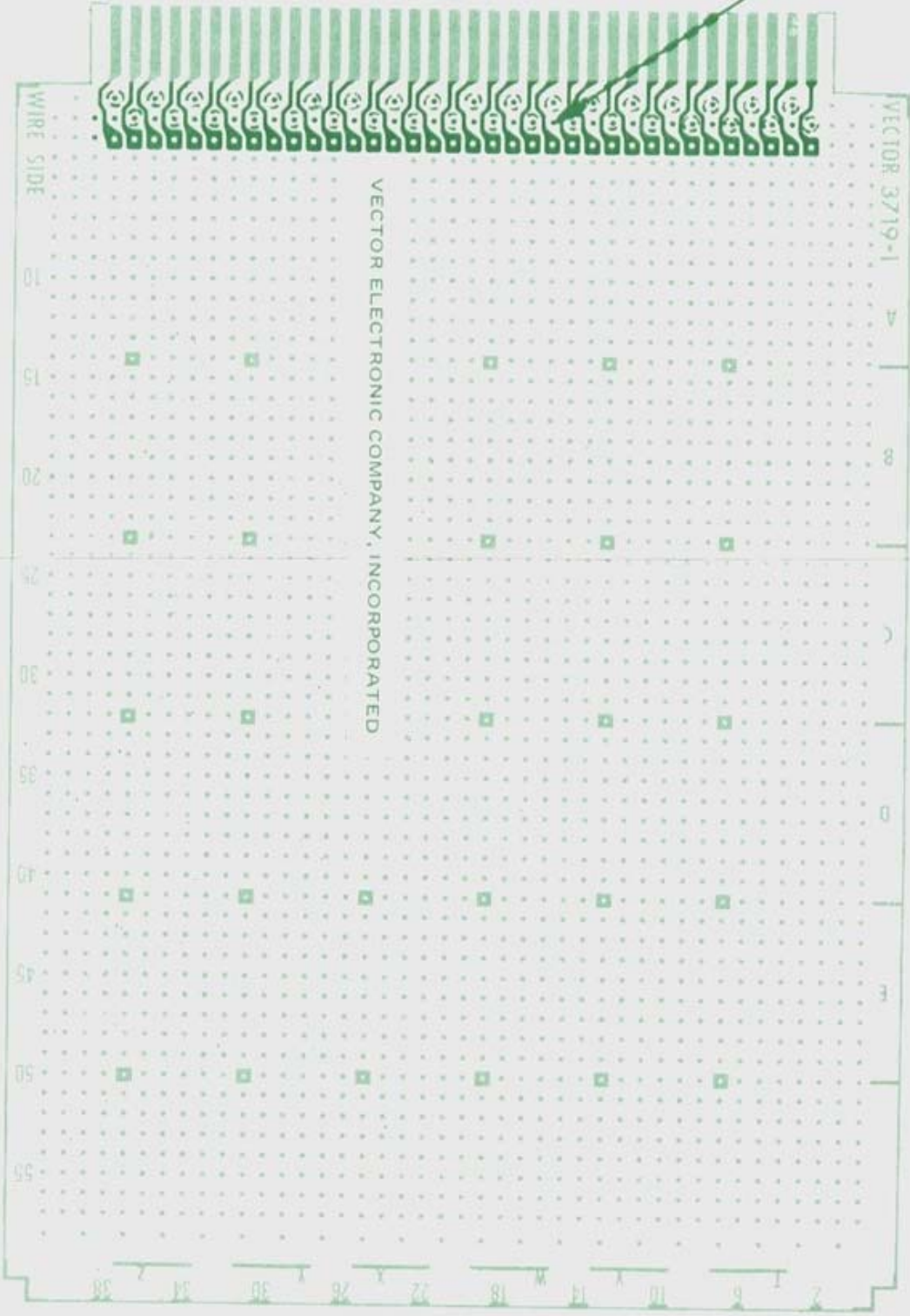


FOR 3719-1 6.5" LONG CARDS — COMPONENT SIDE

VECTOR DIP PLUGBOARD™  
 PATTERN 0.042" X 0.10" SPACED HOLES  
 LA12P1 LAYOUT PAPER



WIRING SIDE



**CAUTION:** In any plug contact area on either side of Plugboard, use only those holes having pads. Holes without pads may have insufficient clearance to adjacent circuitry and using them could cause shorting.

= NO. 1 DIP PIN POSITION

4. BEFORE PRESSING TERMINALS INTO BOARD POSITION (ROTATE) TERMINALS TO MAXIMIZE THE CLEARANCE BETWEEN THE WIDEST PART OF THE TERMINAL AND THE NEAREST ADJACENT CONDUCTOR.

3. INTENDED FOR USE IN NON-HOSTILE ENVIRONMENTS UP TO 200 VOLTS RMS OR 300 VOLTS DC.

2. DOTTED CIRCLES REPRESENT PLUG PADS ON OPPOSITE SIDE OF BOARD.

1. ZONE LETTERS A,B,C, ETC. ON Y AXIS AND X,Y,Z ON X AXIS MARK POSITION FOR 14- OR 16-PIN DIPS.

NOTES

VECTOR D.I.P. PLUGBOARD  
 "P" PATTERN (.042" DIA. ON 0.1" SPACED HOLES)  
 LA12P2 LAYOUT PAPER

